

THAPAR INSTITUTE OF ENGINEERING & TECHNOLOGY, PATIALA
(Deemed to be University)
CENTRE FOR INDUSTRIAL LIAISON AND PLACEMENT

Dated: 20.11.2024

CAMPUS INTERVIEWS

1. ■ Name of the Organization: ■ Amazon
(www.amazon.com)

(Profile –SDE role)

Branches of Engineering: ■ BE –CS (All branches) /EE /EEC
■■■■■■■■■■

Eligibility Criteria ■■ Present CGPA ■■ 6.50 ■
■■
■■ (No active backlogs)
■■■■

Process of Interviews: ■■ Short listing based upon your details
Online Assessment
Two rounds of Interview

2. ■ Virtual PPT and Online test on ____ November, 2024 at 3.00 PM
■ Virtual Interviews on ____ November, 2024 at

3. ■ Submit the details & resume as per organizational format to the below TIET Google link by
■ <https://forms.gle/jyn1fG1oGbZvZfdG8>

4. ■ CTC ■ ~ ■ Stipend- 1,10,000 per month and \$400 relocation allowance

LOI will be provided based on performance, compensation will be shared at the time of LOI. B

5. ■ Job location: ■ Bangalore. Hyderabad. Chennai